1. Overview

The debugging MCU board R0E5562GAPFK00 (hereafter referred to as “this product”) is for MCUs of the RX62T and RX62G groups in the PLQ0100KB-A package.

With the E20 emulator, the emulator occupies some user port pins for controlling the emulator and output of trace information. These user port pins must be connected with a 38-pin connector installed on the user system.

With this product, however, all user port pins are available for the user system. In addition, you do not need to install a 38-pin connector on the user system.

Figure 1 shows the configuration of a system that includes this product and an E20.

Be sure to read section 7, Notes on Usage, before using this product.

![Figure 1: System Configuration](image)

2. Components of this Product

Table 1 lists the components of this product. Check that you have all of the components when you unpack the box.

<table>
<thead>
<tr>
<th>Component</th>
<th>Quantity</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>Debugging MCU board (R0E5562GAPFK00)</td>
<td>1</td>
<td>For the dimensions of the board, refer to section 6, Dimensions of this product.</td>
</tr>
<tr>
<td>YQPACK100SD (from Tokyo Eletech Corporation)</td>
<td>1</td>
<td>Connector to be placed between this product and the NQPACK.</td>
</tr>
<tr>
<td>NQPACK100SD-ND (from Tokyo Eletech Corporation)</td>
<td>1</td>
<td>IC socket for mounting on the user system</td>
</tr>
<tr>
<td>YQ-GUIDE-S1 (from Tokyo Eletech Corporation)</td>
<td>4</td>
<td>Screws for fastening the YQPACK to the NQPACK.</td>
</tr>
<tr>
<td>Cautions in handling</td>
<td>1</td>
<td>Cautions when handling the products of Tokyo Eletech Corporation</td>
</tr>
<tr>
<td>User’s Manual (English and Japanese)</td>
<td>1 for each</td>
<td>This manual (English)</td>
</tr>
</tbody>
</table>

Note: NQPACK, YQPACK, YQSOCKET, YQ-GUIDE, HQPACK, TQPACK, TQSOCKET, CSSOCKET, CSPlug/W, and LSPACK are trademarks of Tokyo Eletech Corporation.
### Important

**CAUTION**

<table>
<thead>
<tr>
<th>Caution to Be Taken for Disposal:</th>
</tr>
</thead>
<tbody>
<tr>
<td>Penalties may be applicable for incorrect disposal of this waste, in accordance with your national legislation.</td>
</tr>
</tbody>
</table>

**European Union regulatory notices:**

The WEEE (Waste Electrical and Electronic Equipment) regulations put responsibilities on producers for the collection and recycling or disposal of electrical and electronic waste. Return of WEEE under these regulations is applicable in the European Union only. This equipment (including all accessories) is not intended for household use. After use the equipment cannot be disposed of as household waste, and the WEEE must be treated, recycled and disposed of in an environmentally sound manner. Renesas Electronics Europe GmbH can take back end of life equipment, register for this service at "http://www.renesas.eu/weee".

<table>
<thead>
<tr>
<th>Caution to Handling this product:</th>
</tr>
</thead>
<tbody>
<tr>
<td>• Take full care not to touch any parts or cause short circuits on this product.</td>
</tr>
<tr>
<td>• Protect this product from excessive physical shock.</td>
</tr>
<tr>
<td>• Do not alter this product. If any alteration is attempted, this product will no longer be supported.</td>
</tr>
<tr>
<td>• The MCU installed on this product is only for use in debugging. Do not remove the MCU from the board to use it for other purposes.</td>
</tr>
</tbody>
</table>

For purchasing the NQPACK100SD-ND, YQPACK100SD and HQPACK100SD, contact the following:

Tokyo EleTech Corporation      http://www.tetc.co.jp/e_index.

<table>
<thead>
<tr>
<th>Caution to Notes on Turning the Power On:</th>
</tr>
</thead>
<tbody>
<tr>
<td>• Do not apply a power voltage that is beyond the range guaranteed for the MCU.</td>
</tr>
<tr>
<td>• Only supply power to this product and connected parts after having connecting all cables.</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Cautions for Use Temperature:</th>
</tr>
</thead>
<tbody>
<tr>
<td>This product is to be used in an environment with a maximum ambient temperature of 35°C.</td>
</tr>
<tr>
<td>Care should be taken that this temperature is not exceeded.</td>
</tr>
</tbody>
</table>

### European Union regulatory notices

This product complies with the following EU Directives.

**Environmental Compliance and Certifications:**

- Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2002/95/EC
3. Specifications

Table 2 shows the functional specifications of this product.

<table>
<thead>
<tr>
<th>Item</th>
<th>Specification</th>
</tr>
</thead>
<tbody>
<tr>
<td>MCU for use</td>
<td>• RX62T and RX62G groups MCUs in PLQP0100KB-A packages</td>
</tr>
<tr>
<td>The MCU type name installed on this product</td>
<td>• R5F562GABDFH (exclusive for debugging) (ROM: 256 Kbytes, RAM: 16 Kbytes, Data flash: 32 Kbytes)</td>
</tr>
<tr>
<td>Power supply</td>
<td>• Power(VCC) at 2.7 to 3.6 V, or 4.0 to 5.5 V is supplied from the user system.</td>
</tr>
<tr>
<td></td>
<td>• Power(AVCC0 = AVCC) at 3.0 to 3.6 V, or 4.0 to 5.5 V is supplied from the user system.</td>
</tr>
<tr>
<td></td>
<td>• The state of power supply can be monitored through the test pins (TP1 for VCC and TP2 for GND).</td>
</tr>
<tr>
<td></td>
<td>• The state of analog power supply can be monitored through the test pins (TP3 for AVCC0, TP4 for VREFH0, TP5 for AVCC, and TP6 for VREF).</td>
</tr>
<tr>
<td>System clock (EXTAL)</td>
<td>• This clock signal at 8 to 12.5 MHz is supplied from the user system.</td>
</tr>
</tbody>
</table>

Notes*: 1. Please use it by voltage (VCC > V_{POR}) that doesn't enter the state of power on reset.

4. Reset Circuit

Figure 2 shows the reset circuit, with the level on the RES# pin pulled up by a 510-kΩ resistor.

![Figure 2  Reset Circuit](image)

Notes*: 1. Indicated pin numbers are for pins of the 38-pin connector (CN1).
2. Indicated pin numbers are for pins of the YQSOCKET100SDF (CN2).
5. Connection
To connect this product and user system, follow the procedure below.

This Product (R0E5562GAPFK00) can be used for debugging and on-board evaluation in common by mounting the NQPACK100SD-ND on the user system.

(1) For debugging
1. Mount the NQPACK100SD-ND on the user system.
   Be sure to check that the location of pin 1 is correct.
2. Install the YQPACK100SD after checking for a match with the position of pin 1 for the NQPACK100SD-ND. Then use the YQ-GUIDE-S1 to affix the YQPACK100SD to the NQPACK100SD-ND.
   - Do NOT use the screws included with the YQPACK100SD for fixing the YQPACK100SD.
   - Do NOT use the screwdriver included with the NQPACK100SD-ND for fixing the YQ-GUIDE-S1. That is used only for the HQPACK100SD. Note that you need to provide your own screwdriver.
3. Connect this product after checking for a match with the position of pin 1 for the YQPACK100SD.
4. Install the connector of the flexible cable from the emulator to the 38-pin connector on this product. Hold this product while connecting the cable to avoid imposing heavy pressure on the 38-pin connector of this product.

(2) For on-board evaluation
5. Mount an MCU with on-chip flash memory and the HQPACK100SD (not included) in order on the NQPACK100SD-ND on the user system.

Before using this product, be sure to read section 7, Notes on Usage.

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**WARNING**

**Warning to Connection:**
- Always switch OFF the emulator, this product, and user system before connecting or disconnecting the emulator. Failure to do so will create a FIRE HAZARD and will damage the emulator, this product, and user system.
- Make sure that the connectors on both ends of the user-system interface cable are facing the right way relative to the user-side connector on the emulator and the 38-pin connector on this product, respectively. Incorrect connection will create a FIRE HAZARD and will damage the emulator, this product, and user system.

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**CAUTION**

**Caution to Mount the NQPACK:**
- Check the locations of pin 1 before mounting the NQPACK.
- The tightening torque must be no greater than 0.054 N·m. If the applied torque is not accurately measurable, stop tightening when the force required to turn the screw (YQ-GUIDE-S1) becomes significantly greater than that required at the start of tightening. Tightening a screw too much may break the screw hole of the NQPACK or lead to a faulty connection by cracking solder on the NQPACK side.
- Failure of conduction during operation may be due to a crack in the solder for the NQPACK. Check conduction with a tester and re-solder the NQPACK as required.
6. Dimensions of this Product

Figures 4 shows the dimensions and reference pad pattern of this product (R0E5562GAPFK00).

Figure 4   Reference Pad Pattern and Dimensions of this product (R0E5562GAPFK00)
7. Notes on Usage

READ the following warnings before using this product. Incorrect operation will damage this product and user system. The USER PROGRAM will be LOST.

Notes on Connecting this product:
- Cables must not be connected or removed while the power is on.
- Before connecting this product and user system, check that the pin 1 locations on both sides are correctly aligned with each other.

Notes on Rewriting the Flash Memory:
- The number of times that the flash memory in the MCU installed on this product can be programmed is limited. If an error in erasure occurs during debugging, replace this product.

Notes on Debugging:
- This product is only usable for debugging when it is connected to the user system.
- Debugging by this product alone is not supported.

Notes on Starting the Debugger and Selecting the MCU Type:
- Select the MCU type for use in the device name section of the [Initial Settings] dialog box on initiation of the debugger.

Note on Differences between the MCU to be debugged and this Product:
- The sizes of the ROM, RAM, and data flash of the MCU installed in this product are 256 KB, 16 KB and 32 KB, respectively. Note that if the MCU to be debugged has the ROM, RAM, or data flash which is smaller in size than that of this product, access can be made to the differential area.

Notes on Designing the User System:
- Pull the levels on the EMLE pin down to 4.7 kΩ to 10 kΩ.
- Pull the levels on the MD0 and MD1 pins up to 4.7 kΩ to 10 kΩ, and select the single-chip mode.
- Pull up or down the level on the MDE pin according to the endian used.
- The output of the reset circuit of the user system must be open collector.

Notes on the Flash Development Toolkit (FDT):
- Do not use the FDT when using the debugging MCU board.

Notes on the Writing the On-chip Flash Memory Mode:
- If the debugger has an exclusive mode for flash writing (e.g. “writing the on-chip flash memory mode” of High-performance Embedded Workshop), do not use the mode.

Notes on the A/D Converter:
- The characteristics of the A/D converter differ from those of actual MCU because there are a converter board and other devices between the MCU and the user system.

Notes on the Hot Plug-in function:
- Do not use the hot plug-in function when using this product.
Precautions

This product is only intended for use in a laboratory environment under ambient temperature and humidity conditions. A safe separation distance should be used between this and any sensitive equipment. Its use outside the laboratory, classroom, study area or similar such area invalidates conformity with the protection requirements of the Electromagnetic Compatibility Directive and could lead to prosecution.

The product generates, uses, and can radiate radio frequency energy and may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment causes harmful interference to radio or television reception, which can be determined by turning the equipment off or on, you are encouraged to try to correct the interference by one or more of the following measures;

• ensure attached cables do not lie across the equipment
• reorient the receiving antenna
• increase the distance between the equipment and the receiver
• connect the equipment into an outlet on a circuit different from that which the receiver is connected
• power down the equipment when not in use
• consult the dealer or an experienced radio/TV technician for help

NOTE: It is recommended that wherever possible shielded interface cables are used.

The product is potentially susceptible to certain EMC phenomena. To mitigate against them it is recommended that the following measures be undertaken;

• The user is advised that mobile phones should not be used within 10m of the product when in use.
• The user is advised to take ESD precautions when handling the equipment.

This product does not represent an ideal reference design for an end product and does not fulfill the regulatory standards for an end product.

8. Warranty

1. The warranty of your product is valid for one year after purchase.

   If your product becomes faulty or damaged while being used under good conditions by observing this user's manual, we will repair or replace your faulty or damaged product free of charge.

2. Note, however, that if your product's fault or damage is raised by any one of the following causes, the warranty is void.

   a) Misuse, abuse, or use under extraordinary conditions
   b) Improper handling such as dropping your product during transportation or carriage
   c) Other connected equipments
   d) Fires, earthquakes, lightning, flood and other unexpected disasters, damages and abnormal voltage.
   e) Unauthorized remodeling, repair, adjustment, and so on

In the above cases, contact your local distributor.

If your product is being leased, consult the leasing company or the owner.
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Renesas Electronics Corporation

Refer to "http://www.renesas.com/" for the latest and detailed information.

Renesas Electronics America Inc.
2890 Scott Boulevard, Santa Clara, CA 95054-2554, U.S.A.
Tel: +1-408-588-6000, Fax: +1-408-588-6130

Renesas Electronics Canada Limited
1101 Nicholson Road, Nepean, Ontario, L4Y 9C3, Canada.
Tel: +1-613-598-5441, Fax: +1-613-899-3220

Renesas Electronics Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: +44-1628-651-700, Fax: +44-1628-651-654

Renesas Electronics Europe GmbH
Maxstrasse 10, 4047 Dusseldorf, Germany
Tel: +49-211-6503-0, Fax: +49-211-6505-1327

Renesas Electronics (China) Co. Ltd.
7th Floor, Qucmum Plaza, No.24 ZhongGuoLu, Haidian District, Beijing 100083, P.R. China
Tel: +86-10-8225-1155, Fax: +86-10-8225-7678

Renesas Electronics (Shanghai) Co. Ltd.
Unit 204, 205, AIA Center, No.1235 LuPu Ring Rd, Pudong District, Shanghai 200120, China
Tel: +86-21-5397-1818, Fax: +86-21-6887-7568 / 7598

Renesas Electronics Hong Kong Limited
Unit 1501-1513, 16/F, Tower 2, Grand Century Plaza, 193 Prince Edward Road West, Mong Kok, Kowloon, Hong Kong
Tel: +852-2886-8381, Fax: +852-2886-2023

Renesas Electronics Taiwan Co., Ltd.
13F, No. 365, Fu Shih North Road, Taipei, Taiwan
Tel: +886-2-2817-9650, Fax: +886-2-2817-9670

Renesas Electronics Singapore Pte. Ltd.
80 Bendemeer Road, Unit 06-02 Nuvella Innovation Centre Singapore 339549
Tel: +65-6213-0200, Fax: +65-6213-0300

Renesas Electronics Malaysia Sdn. Bhd.
Unit 1B, Block B, Menara Amcorp, Amcorp Trade Centre, No. 18, Jln Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia
Tel: +603-7955-9390, Fax: +603-7955-9510

Renesas Electronics Korea Co., Ltd.
11F, Samsung Ladder 9 Building, 702-2 Yeokdam-Dong, Kangnam-Ku, Seoul 135-980, Korea
Tel: +82-2-558-3737, Fax: +82-2-558-5141

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